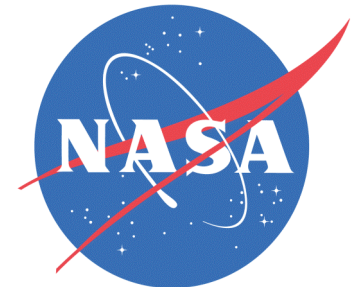


Generalized SiGe HBT Event Rate Predictions Using MRED

Jonathan A. Pellish, R. A. Reed, A. K. Sutton,
R. A. Weller, M. A. Carts, P. W. Marshall,
C. J. Marshall, R. Krithivasan, J. D. Cressler,
M. H. Mendenhall, R. D. Schrimpf, K. M. Warren,
B. D. Sierawski, and G. F. Niu

jonathan.a.pellish@vanderbilt.edu



Preview

- Background
 - Review radiation response in behavior in SiGe HBTs

Preview

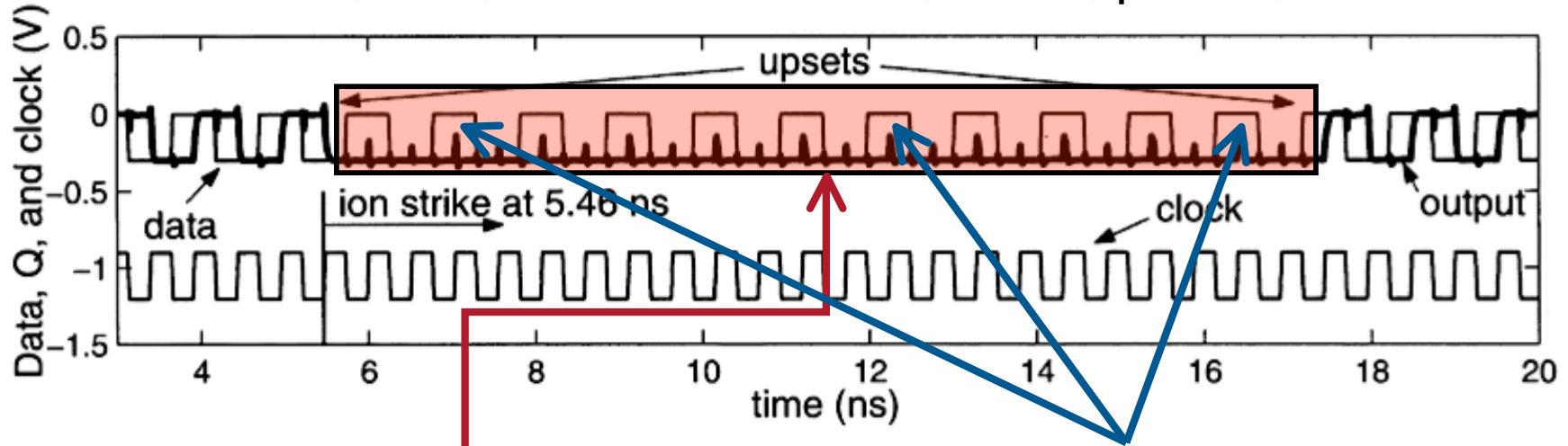
- **Background**
 - Review radiation response in behavior in SiGe HBTs
- **Modeling**
 - Use physical device structures from broadbeam tests
 - Develop generalized radiation response model
 - Broadbeam data, microbeam data, TCAD simulations
 - Employ MRED to calculate energy deposition

Preview

- **Background**
 - Review radiation response in behavior in SiGe HBTs
- **Modeling**
 - Use physical device structures from broadbeam tests
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 - Broadbeam data, microbeam data, TCAD simulations
 - Employ MRED to calculate energy deposition
- **Results**
 - Calibrated to event cross section data (≥ 1 Gbit/s)
 - Calculated event rates for GEO and LEO orbits

Errors in High-Speed Digital Devices

R. Krithivasan, et al., *IEEE Trans. Nucl. Sci.*, vol. 50, p. 2126, Dec. 2003.



Error Intervals (Events)

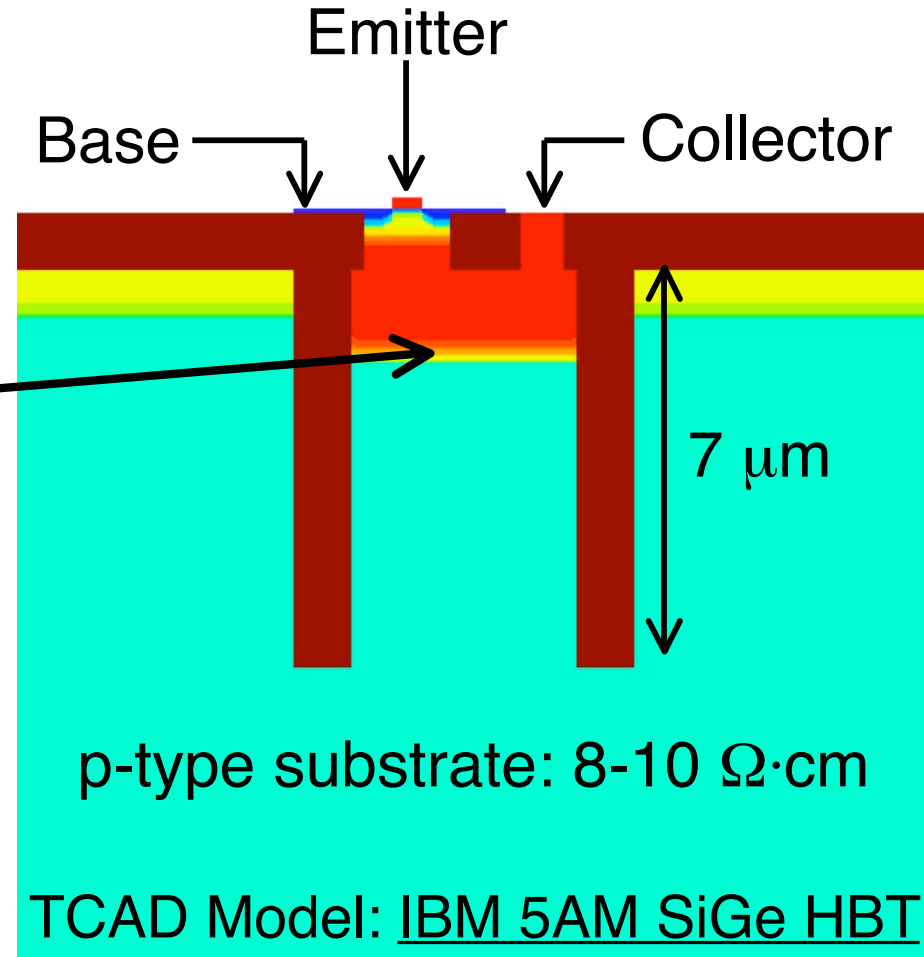
Bit Errors

$$\sigma_{\text{SEU}} = \frac{\# \text{ Error Intervals}}{\Phi}$$

Error intervals used for SEU cross section calculation

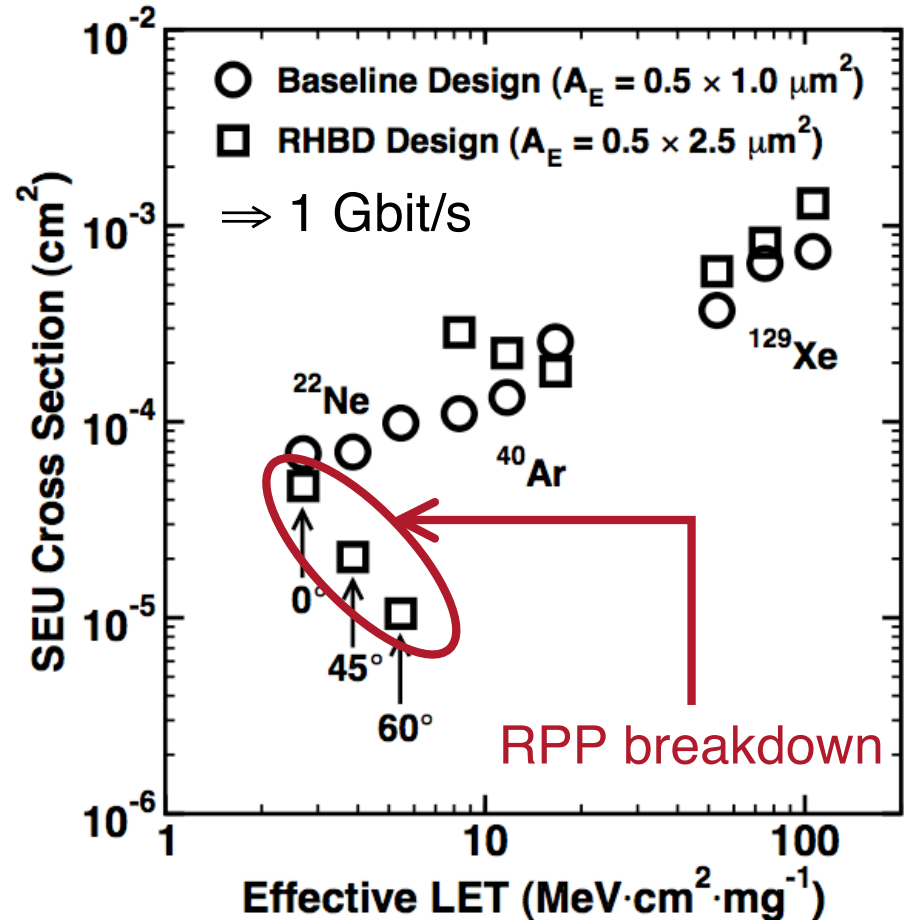
Device and Data Highlights

- Typical bulk SiGe HBT
- SEE-critical features
 - Deep trench isolation
 - Subcollector junction
 - Substrate doping
- Observed non-IRPP response at low LET
 - Decreasing σ_{SEU} with increasing LET_{EFF}



Device and Data Highlights

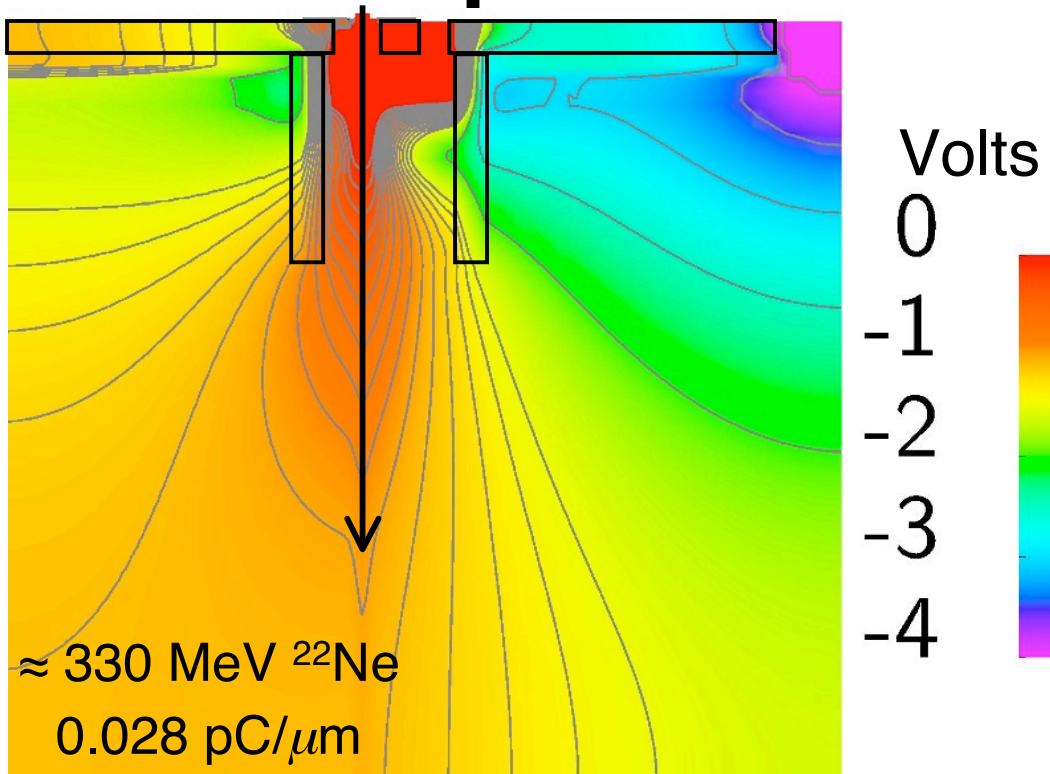
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Data after P. W. Marshall, et al., *IEEE Trans. Nucl. Sci.*, vol. 52, p. 2446, Dec. 2005.

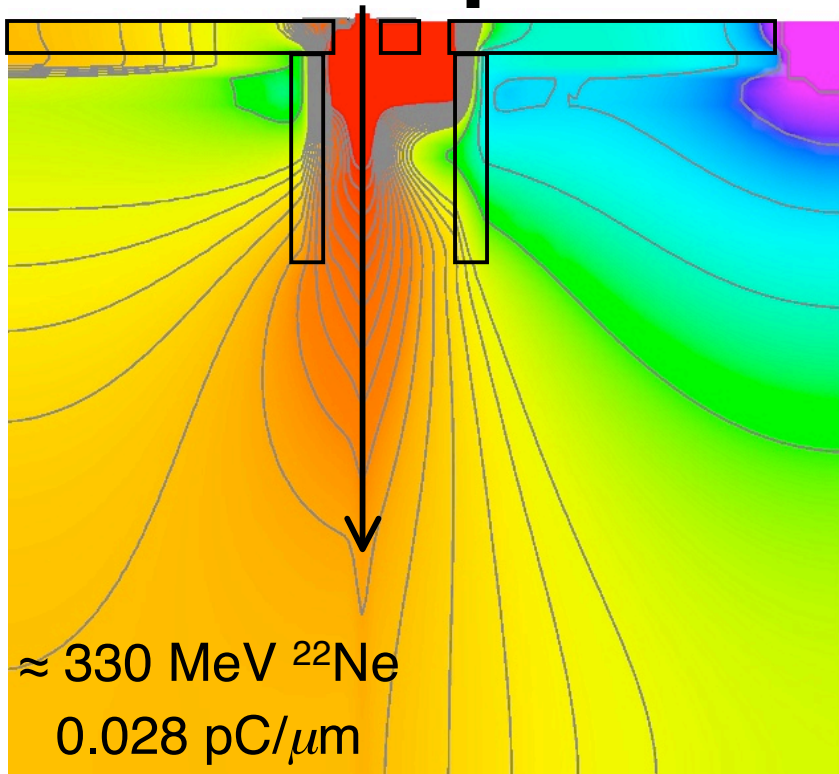
Geometry affects the SEU response of these devices

Ion-Deep-Trench Interaction



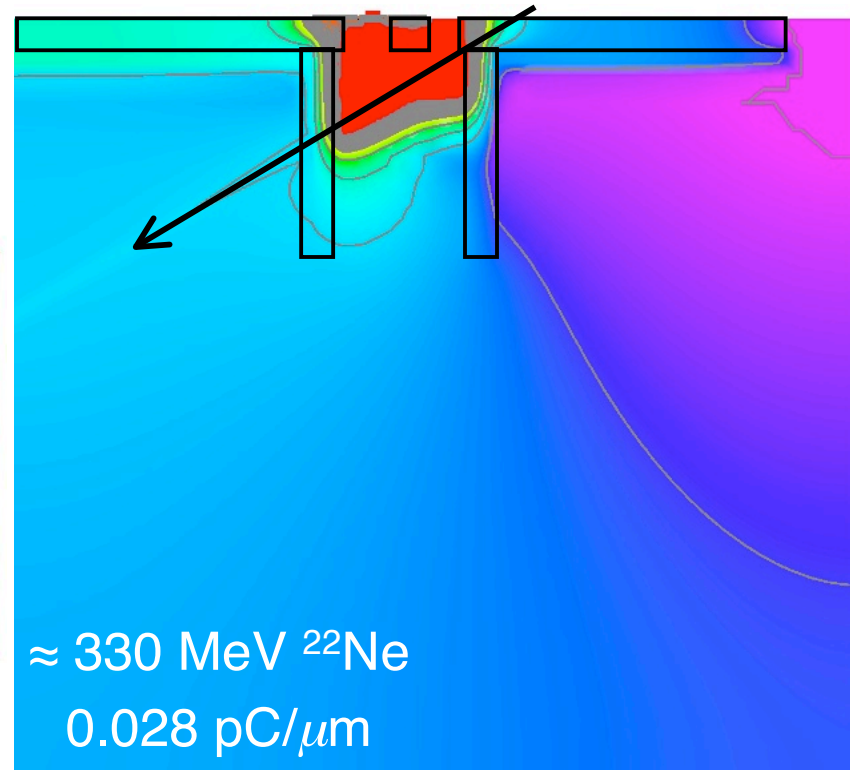
0° strike through emitter

Ion-Deep-Trench Interaction



0° strike through emitter

Volts
0
-1
-2
-3
-4

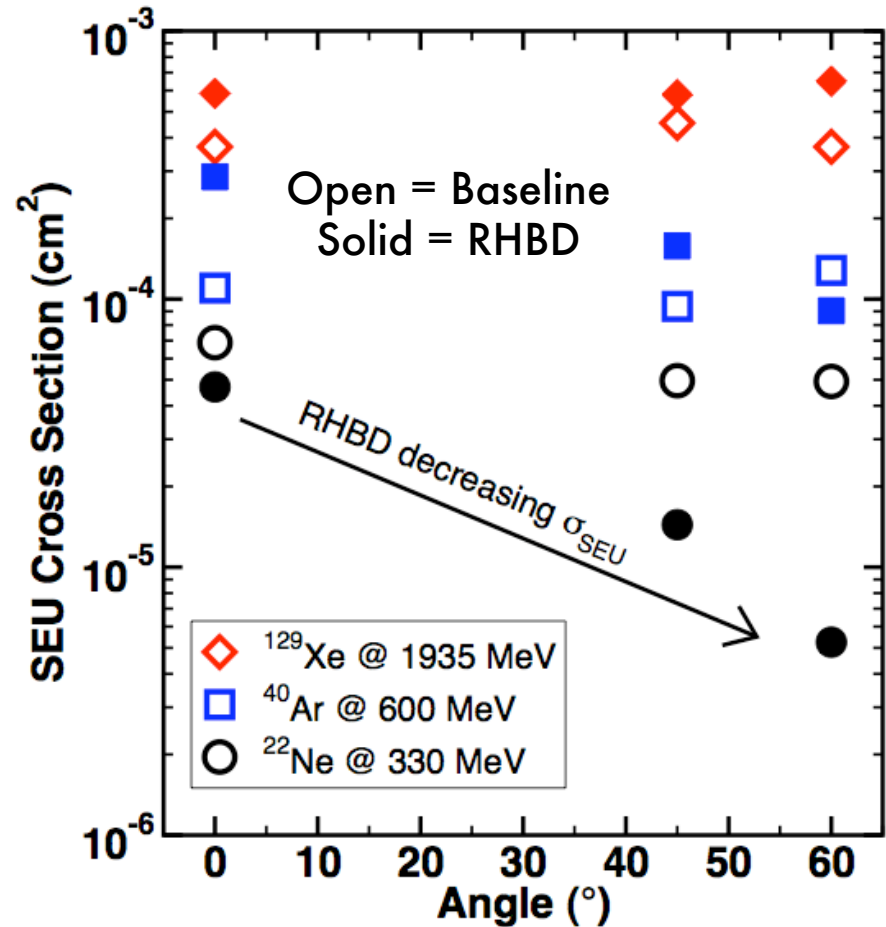


60° strike right-to-left

At grazing angles deep trench mitigates SEU response at larger values of Q_{crit} – important for RHBD devices

SiGe HBT SEU Data - Redefined

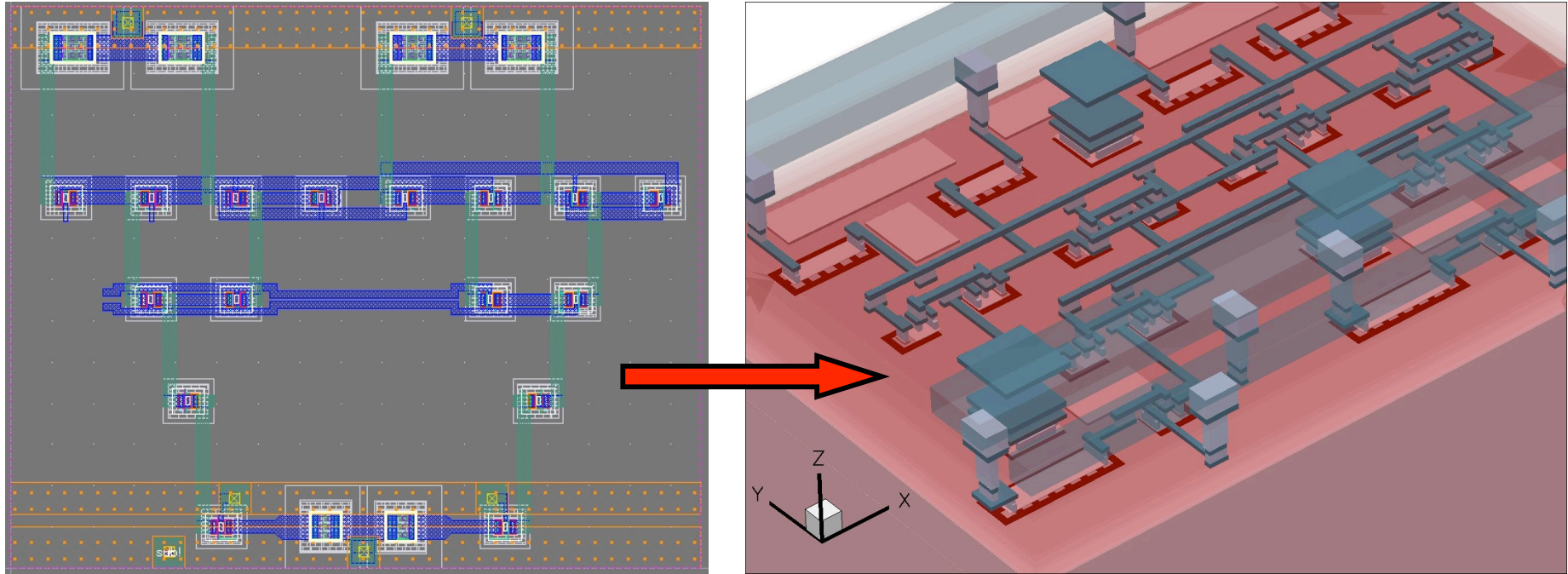
- Shift register data
 - **Baseline design**
 - $A_E = 0.5 \times 1.0 \mu\text{m}^2$
 - **RHBD design**
 - $A_E = 0.5 \times 2.5 \mu\text{m}^2$
- Removed RPP corrections - $\cos(\theta)$
- Normal-incident LETs of 2.8, 8.3, and 53 $\text{MeV}\cdot\text{cm}^2/\text{mg}$



Data after P. W. Marshall, et al., *IEEE Trans. Nucl. Sci.*, vol. 52, p. 2446, Dec. 2005.

Decreasing trend at low LET not accounted for by IRPP model

Transition from GDSII to 3-D



- Use Synopsys TCAD tool suite to convert layout
- Directly imported into MRED for event generation

All subsequent simulations use real GDSII layout information

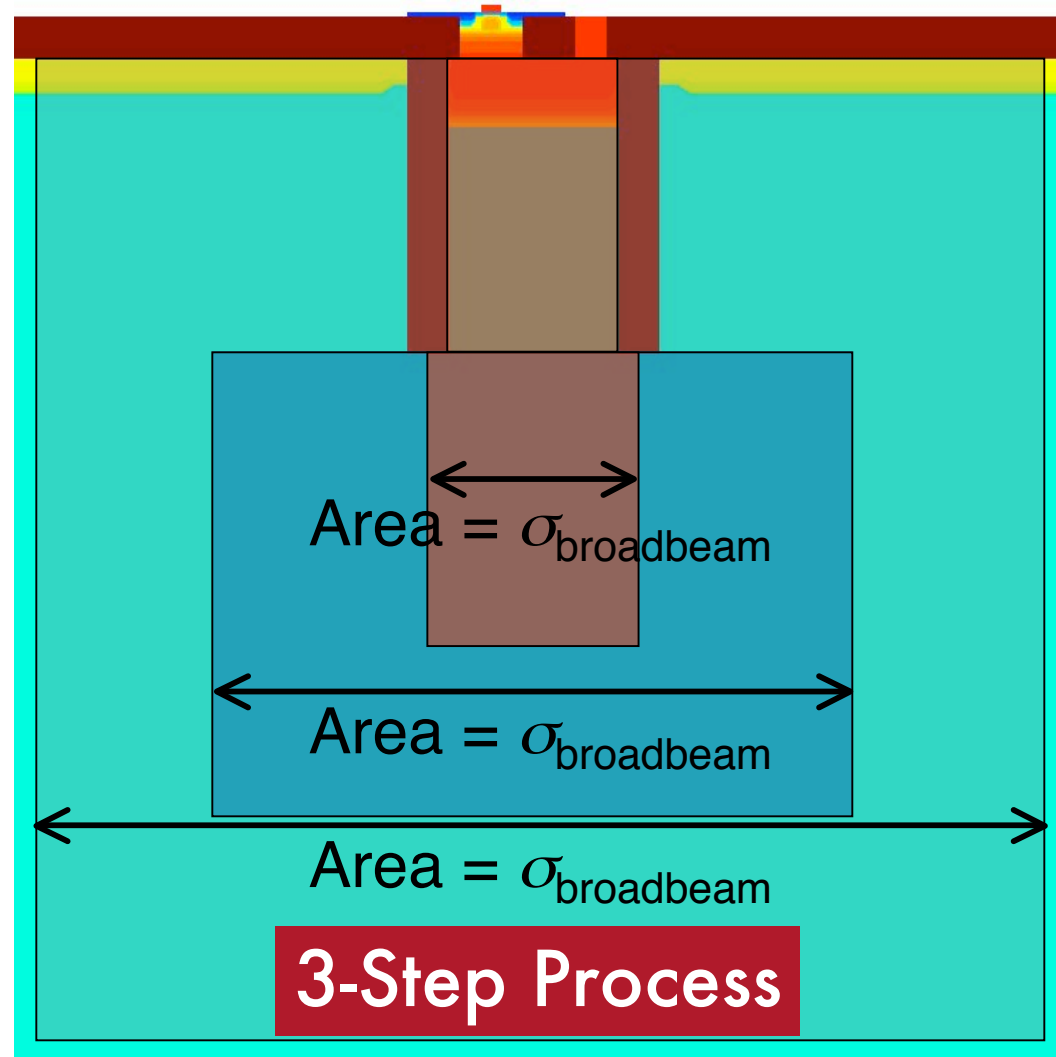
Generalized SiGe HBT Model

- Model provides good approximation to initial conditions, time-evolution
- Total charge collected is weighted sum

$$Q_{\text{coll}} = \sum_i \alpha_i Q_{DL}$$

- K. M. Warren, et al., *IEEE Electron Device Lett.*, vol. 28, p. 180, Feb. 2007.

Same volume structure works for all SiGe HBT technologies simulated



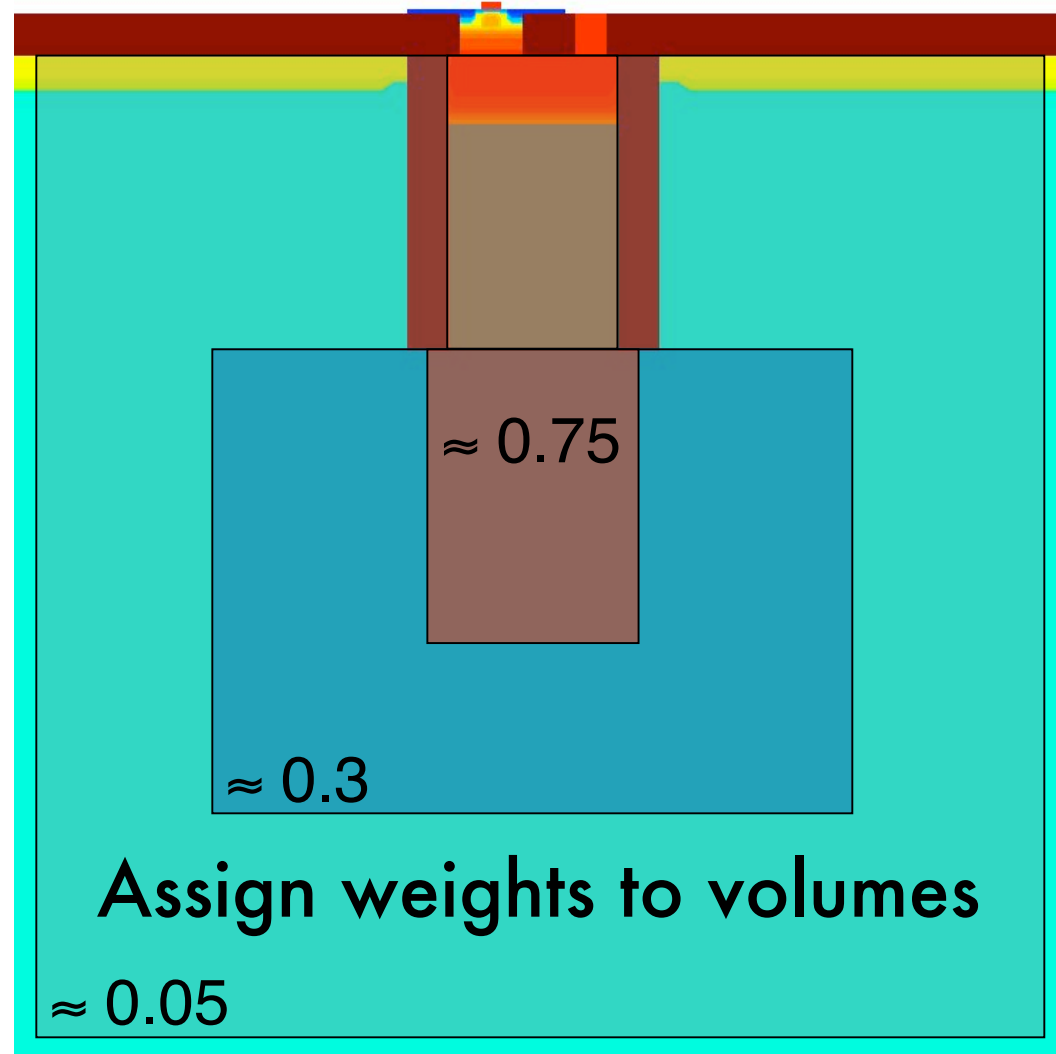
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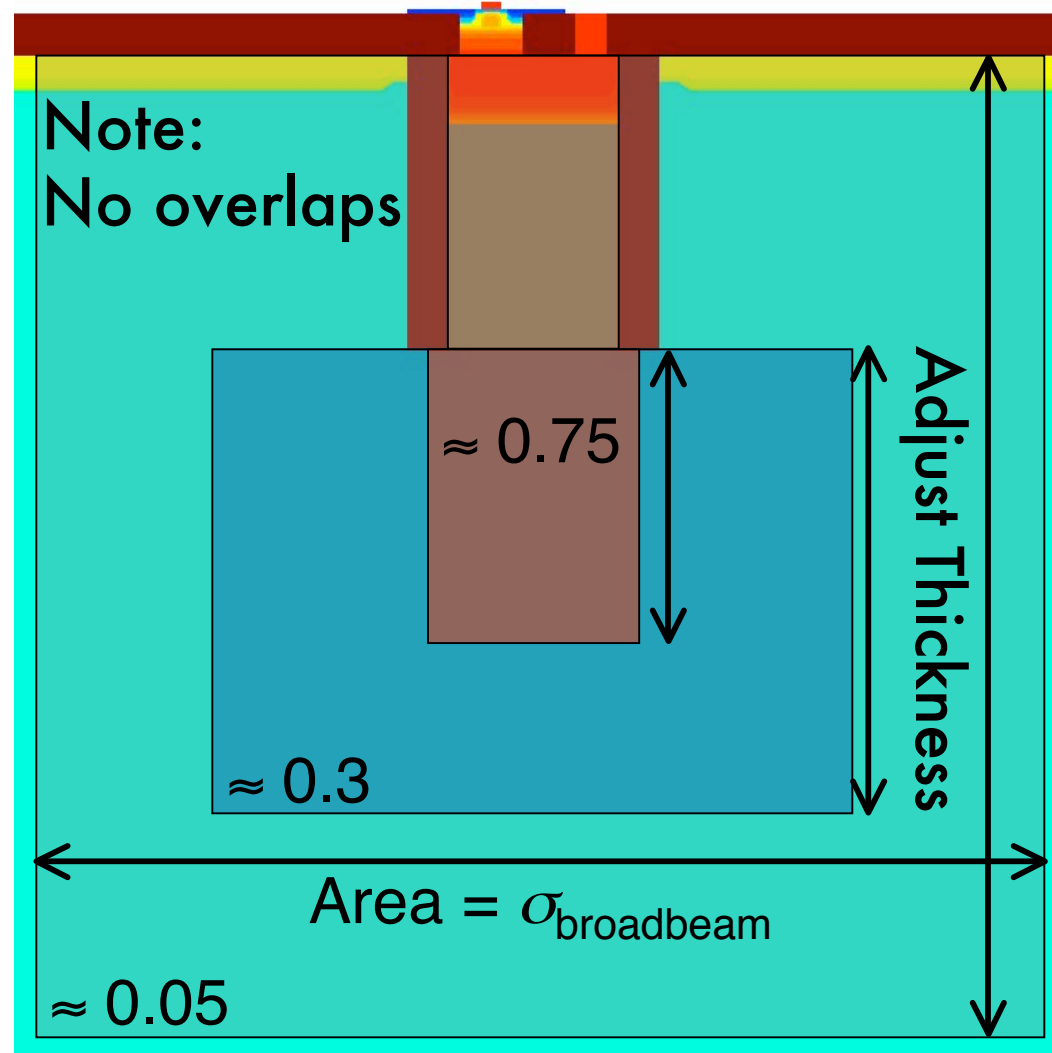
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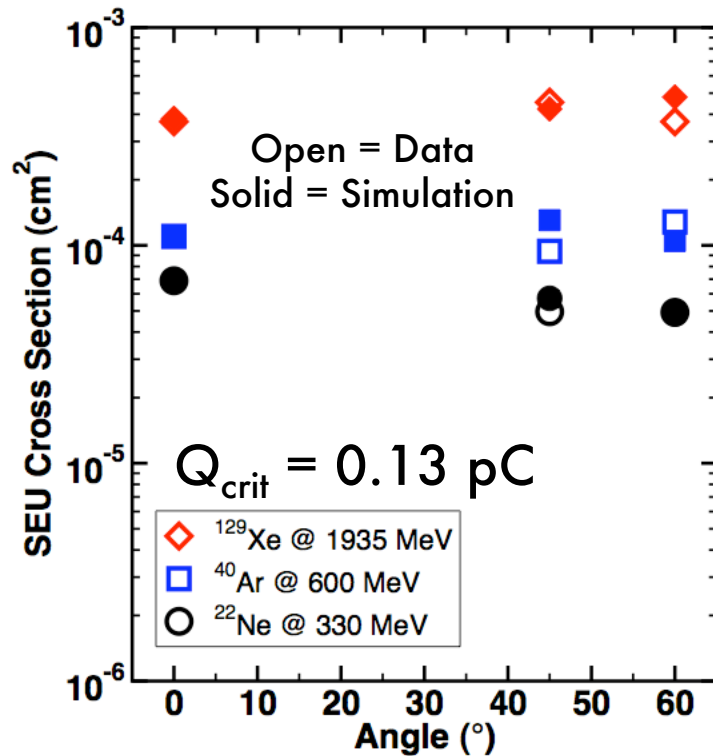
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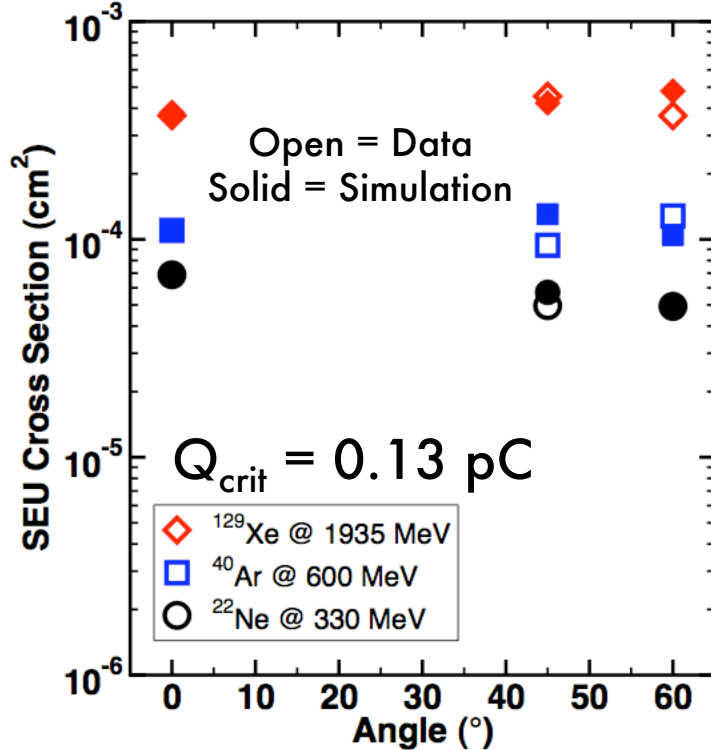
Calibrate to Heavy Ion Data



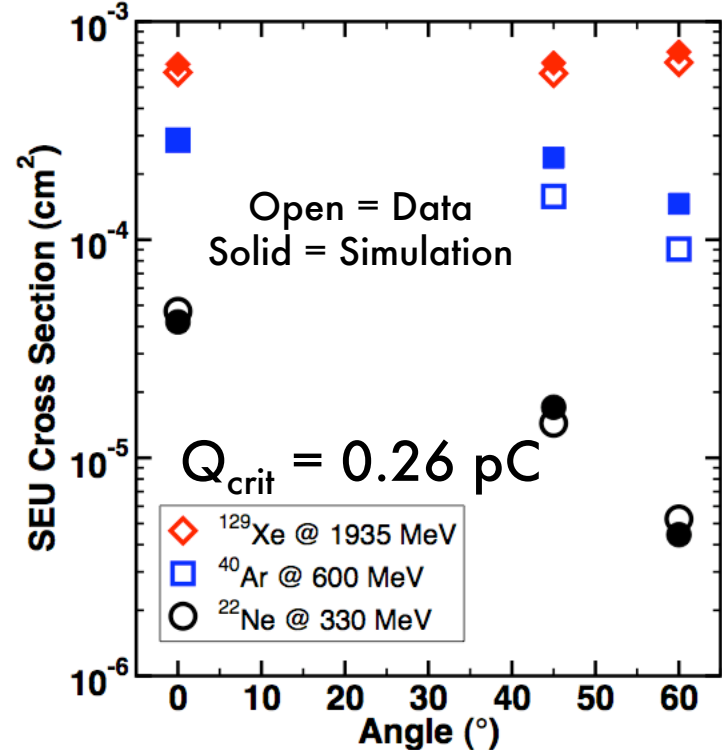
IBM 5AM SiGe HBT Baseline Design

Data after P. W. Marshall, *et al.*, *IEEE Trans. Nucl. Sci.*, vol. 52, p. 2446, Dec. 2005.

Calibrate to Heavy Ion Data



IBM 5AM SiGe HBT
Baseline Design



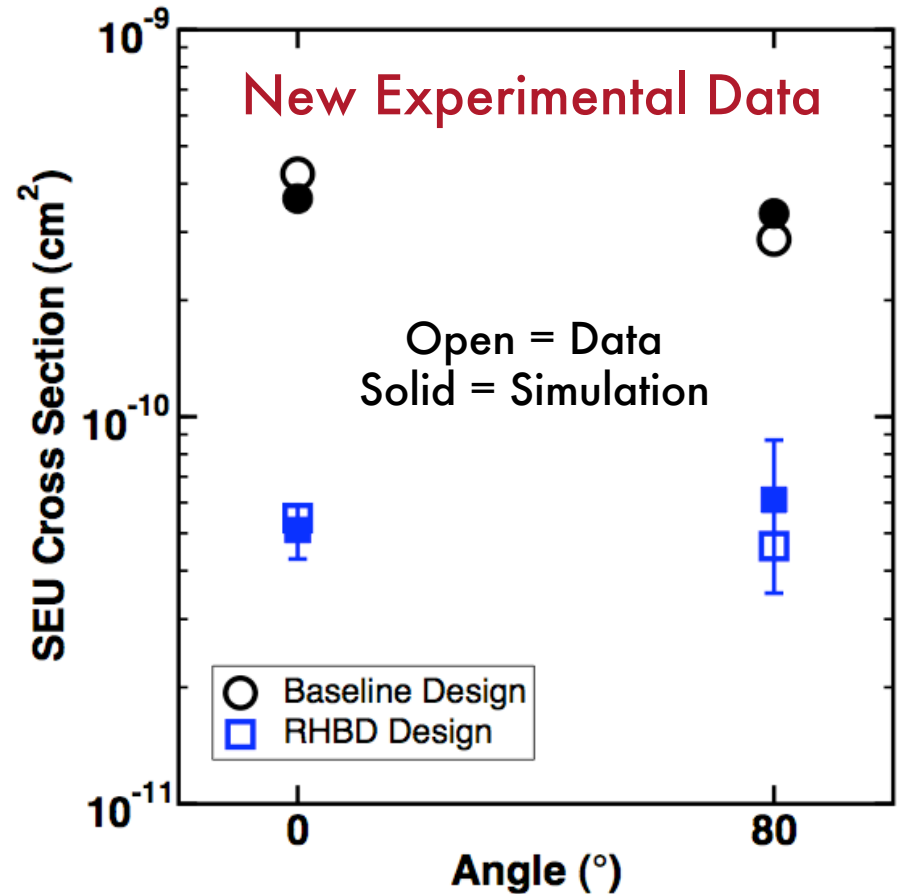
IBM 5AM SiGe HBT
RHBD Design

Data after P. W. Marshall, *et al.*, *IEEE Trans. Nucl. Sci.*, vol. 52, p. 2446, Dec. 2005.

Same sensitive volume model produces required trends

Simulation Compared to Proton Data

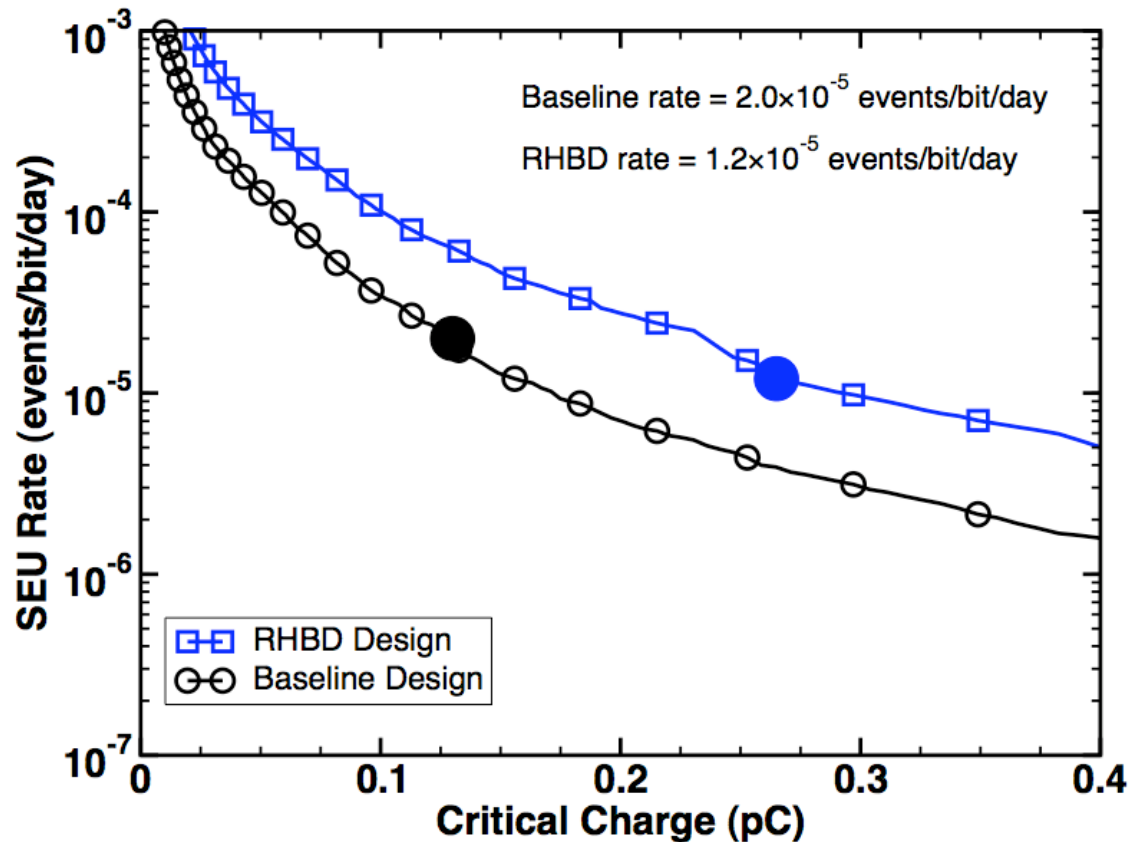
- *No adjustable parameters*
 - *Change particle, energy*
- Different mechanism
 - Direct ionization
 - Nuclear reactions
- Basis for LEO rate calculation in addition to GCR rate calculation
 - Large proton flux component



For protons, no further calibration necessary

Rate Calculations - GCR

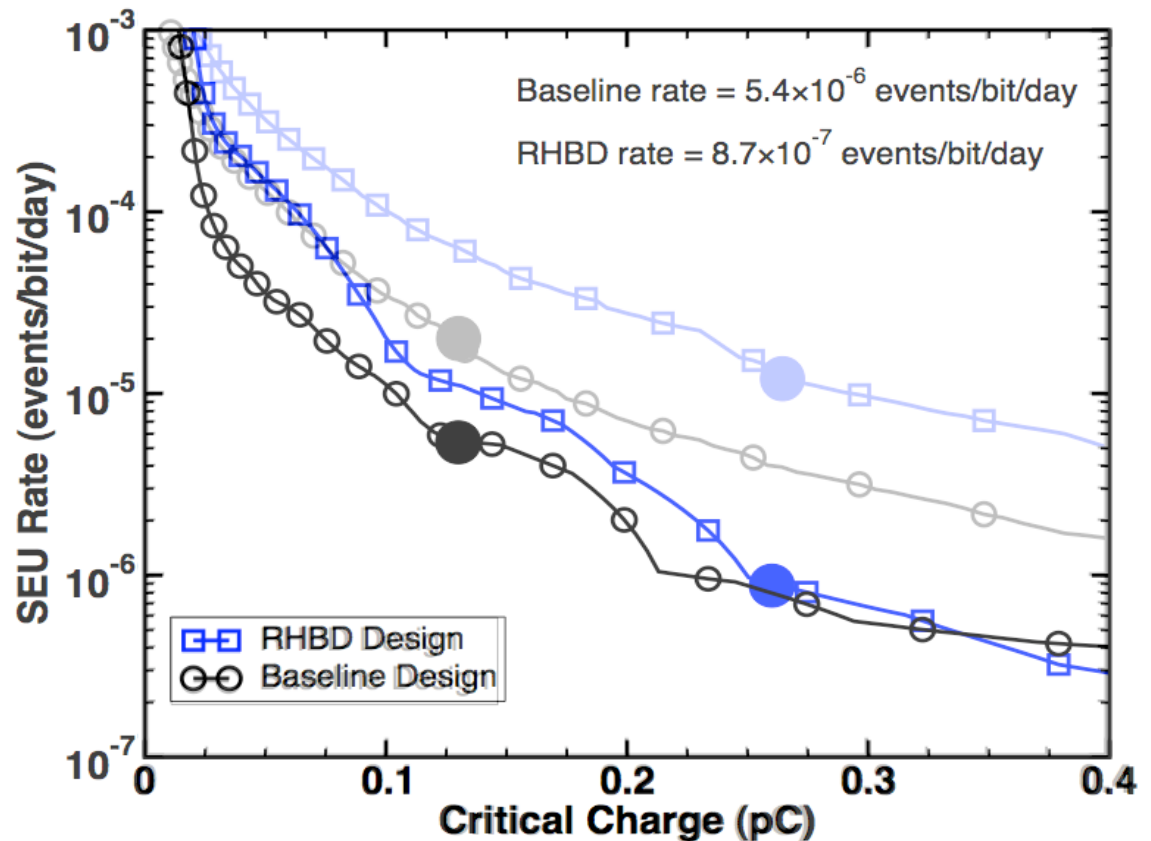
- CREME96 spectra
- Reverse-integrated rate curve (\leq)
- Evaluated at Q_{crit} from broadbeam calibration
- Baseline = 0.13 pC
- RHBD = 0.26 pC
- Rate curve for RHBD higher than baseline
- Lower evaluated rate due to - Q_{crit}



Larger size of RHBD device defeats hardening in GCR

Rate Calculations - LEO

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Due to reduced heavy ion flux at LEO, better benefits with RHBD

Conclusions

- Ion interactions with deep trench isolation result in σ_{SEU} rolloff for devices with high Q_{crit}
- Well-studied technology used to develop generalized approach and provide event rates
 - Linear combination of weighted sensitive volumes
 - User-defined orbits
 - No well-behaved data, no Weibull, no CREME96
- Approach works for CMOS too (already done)
- **Shortfalls: 1.) model cannot predict burst errors, and 2.) event rates are time-independent**

Present Status and Future Work

- This work presented at 2007 NSREC
- SiGe HBT event rate calculations to appear in December 2007 TNS

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- This work presented at 2007 NSREC
- SiGe HBT event rate calculations to appear in December 2007 TNS
- TCAD simulation transient calibration
 - Look for more details in afternoon presentation
 - Moving Single-Event Mechanism Testing and Analysis into the Time-Domain
 - Continued utilization of previous SiGe HBT data
 - IBM Ph.D. Fellowship support
- Complete Ph.D. fall 2008